

**KINGDOM OF CAMBODIA
NATION RELIGION KING**

MINISTRY OF EDUCATION YOUTH AND SPORT
HIGHER EDUCATION IMPROVEMENT PROJECT (HEIP)
IDA CREDIT No. 6221-KH

Date: 25 January 2022

Dear All Bidders,

Subject: Request for Extension of Deadline of Bid Submission for the Procurement of Goods, Package No. MoEYS-HEIP-NS-G-104 for supply, delivery and installation of Research equipment for laser physics.

Reference to the Invitation for Bid posted on Norkor Thom Newspapers, Kos Sontephep, MoEYS Web page and RUPP page on **13 January 2021** and **21 January 2021** for the Procurement of Goods, Package No. MoEYS-HEIP-NS-G-104 for supply, delivery and installation of **Research equipment for laser physics.**

In accordance with RFQ Clause 5: Royal University of Phnom Penh would like to inform you that the Bid Submission Date is going to be extended as followings:

1. Extend the Bid Submission Date **from 31 January 2022 at 3:30 p.m. to 04 February 2022 at 11:15 a.m.**

All other terms conditions and instructions of the bidding documents remain unchanged.

Please acknowledge the receipt and confirm your acceptance in writing or email of this request letter within three working days of the receipt to Royal University of Phnom Penh, Room 604, 6th Floor, STEM Building, Russian Federation Blvd, Sangkat Toek Laark I, Khan Tuol Kork, Phnom Penh, Cambodia. Phone: 078 755 579, 098 556 652, Email: heippu@rupp.edu.kh, kheam.hong@rupp.edu.kh and nou.dararith@rupp.edu.kh

Faithfully Yours, 



PHAL DES
Vice Rector of Royal University of Phnom Penh (RUPP)
and Project Coordinator, HEIP-RUPP

Acknowledgment and Confirmation of the Bidder:

Authorized Representative of Bidder: I confirm of acknowledge receipt of this Request Letter and agreed to extension the deadlines of Bid Submission to the dates specified in the above request letter.

Name:.....Signature.....

Date:.....Stamp of Seal.....